

### Features

- Ideally Suited for Automatic Insertion
- Low Current, Low Voltage
- Epitaxial Planar Die Construction
- Halogen Free. "Green" Device (Note 1)
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## Maximum Ratings @ 25°C Unless Otherwise Specified

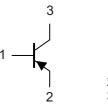
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 285°C/W Junction to Ambient<sup>(Note 2)</sup>
- Thermal Resistance: 215°C/W Junction to Soldering Point

Parameter	Symbol	Rating	Unit	
Collector-Base Voltage	ollector-Base Voltage		-60	V
Collector-Emitter Voltage		V <sub>CEO</sub>	-45	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V	
Continuous Collector Current		I <sub>C</sub>	-800	mA
Peak Collector Current		I <sub>CM</sub>	-1000	mA
Continuous Base Current		I <sub>B</sub>	-100	mA
Peak Base Current		I <sub>BM</sub>	-200	mA
Power Dissipation	T <sub>S</sub> =79°C	PD	330	mW

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine,</li>
<900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>
2. Valid Provided that Leads are Kept at Ambient Temperature.

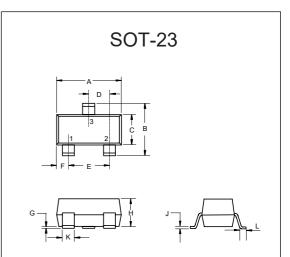
# Marking: DG

### Internal Structure



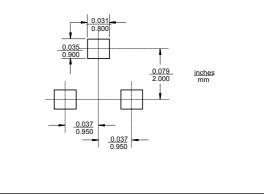
1.BASE
2.EMITTER
3.COLLECTOR
0.00022201010

# PNP Small Signal Transistor



	DIMENSIONS					
DIM	INC	INCHES		М	NOTE	
DIM	MIN	MAX	MIN	MAX	NOTE	
Α	0.110	0.120	2.80	3.04		
В	0.083	0.104	2.10	2.64		
С	0.047	0.055	1.20	1.40		
D	0.034	0.041	0.85	1.05		
E	0.067	0.083	1.70	2.10		
F	0.018	0.024	0.45	0.60		
G	0.0004	0.006	0.01	0.15		
Н	0.035	0.043	0.90	1.10		
J	0.003	0.007	0.08	0.18		
K	0.012	0.020	0.30	0.51		
L	0.007	0.020	0.20	0.50		

#### Suggested Solder Pad Layout



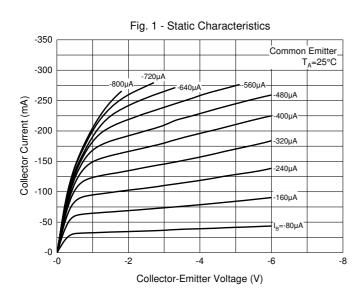


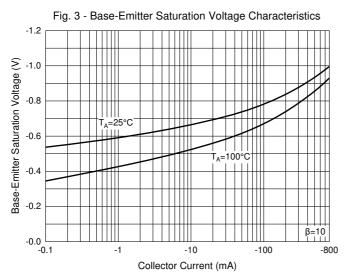
# Electrical Characteristics @ $T_A=25^{\circ}C$ Unless Otherwise Specified

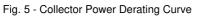
Parameter	Symbol	Min	Тур	Max	Units	Conditions
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-60			V	Ι <sub>C</sub> =-10μΑ, Ι <sub>E</sub> =0
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-45			V	I <sub>C</sub> =-10mA, I <sub>B</sub> =0
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5			V	Ι <sub>E</sub> =-10μΑ, Ι <sub>C</sub> =0
Collector-Base Cutoff Current	I <sub>CBO</sub> -			-20	nA	V <sub>CB</sub> =-45V, I <sub>E</sub> =0
				-20	μA	V <sub>CB</sub> =-45V, I <sub>E</sub> =0, T <sub>A</sub> =150°C
Emitter-Base Cutoff Current	I <sub>EBO</sub>			-20	nA	V <sub>EB</sub> =-4V, I <sub>C</sub> =0
DC Current Gain	h <sub>FE(1)</sub>	50				V <sub>CE</sub> =-10V, I <sub>C</sub> =-100µA
	h <sub>FE(2)</sub>	120				V <sub>CE</sub> =-1V, I <sub>C</sub> =-10mA
	h <sub>FE(3)</sub>	160	250	400		V <sub>CE</sub> =-1V, I <sub>C</sub> =-100mA
	h <sub>FE(4)</sub>	60				V <sub>CE</sub> =-2V, I <sub>C</sub> =-500mA
	V			-0.3	V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			-0.7	V	I <sub>C</sub> =-500mA, I <sub>B</sub> =-50mA
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub> -			-1.25	V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA
				-2.0	V	I <sub>C</sub> =-500mA, I <sub>B</sub> =-50mA
Transition Frequency	f <sub>T</sub>		200		MHz	$V_{CE}$ =-5V,I <sub>C</sub> =-50mA,f=100MHz
Collector-Base Capacitance	C <sub>CB</sub>		6		pF	V <sub>CB</sub> =-10V, f=1MHz
Emitter-Base Capacitance	C <sub>EB</sub>		60		pF	V <sub>EB</sub> =-0.5V, f=1MHz

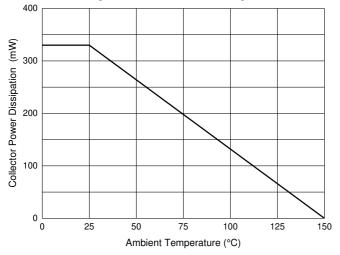


# **Curve Characteristics**









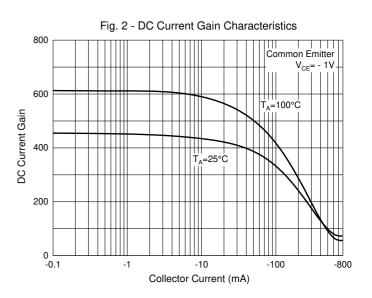
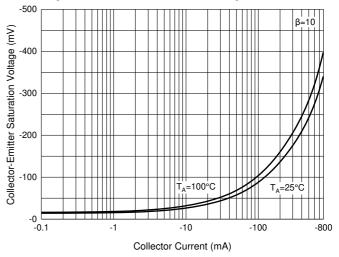


Fig. 4 - Collector-Emitter Saturation Voltage Characteristics





# **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

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